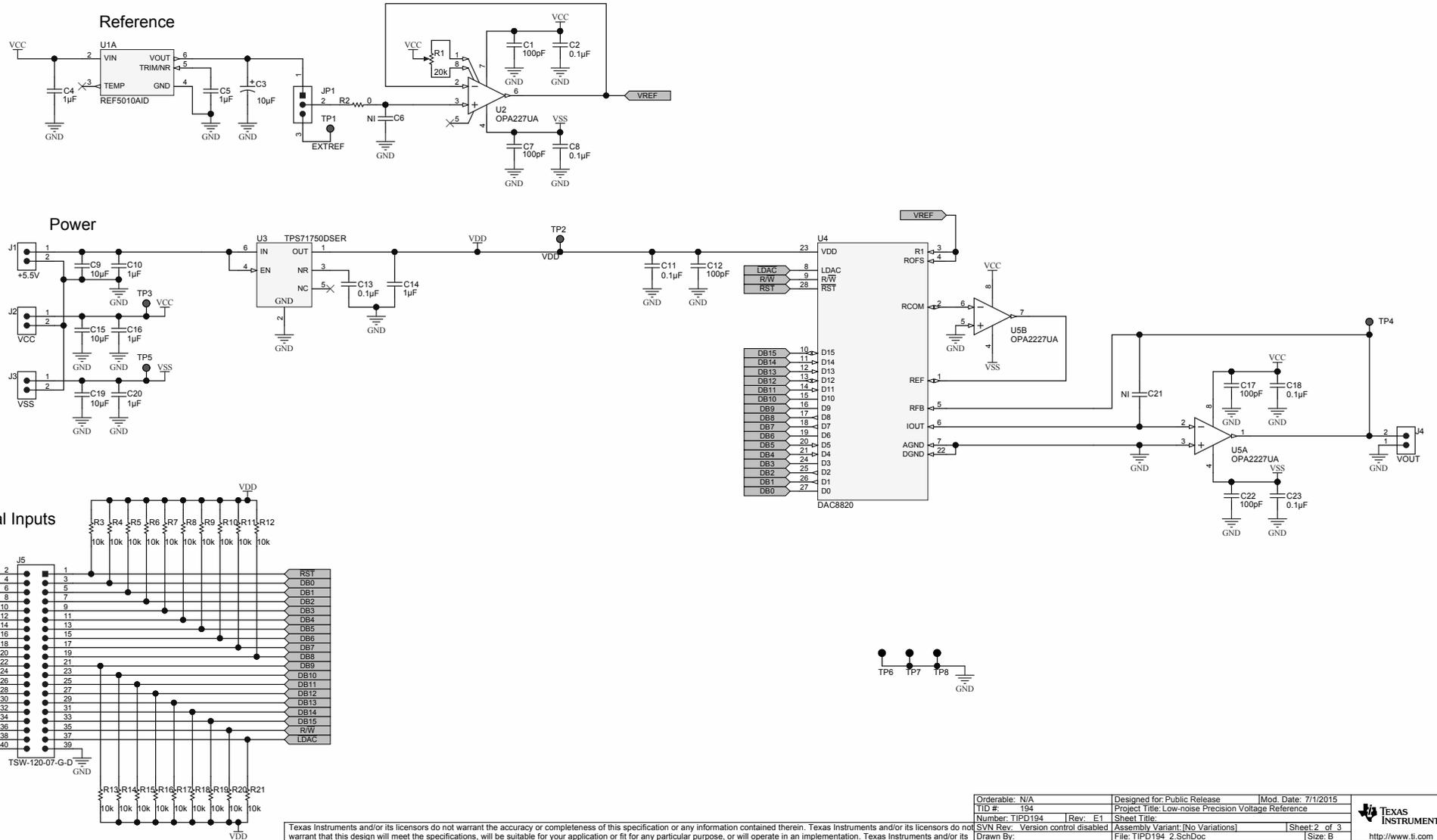


# Low-noise Precision Variable Reference



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Engineer: Eugenio Mejia	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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